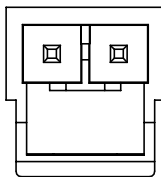
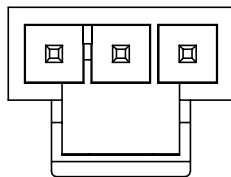
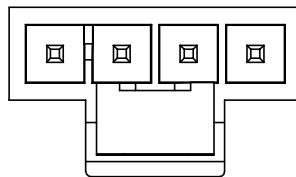
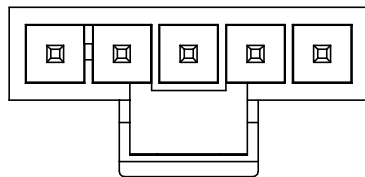
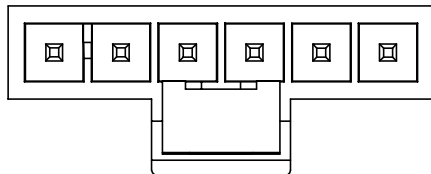
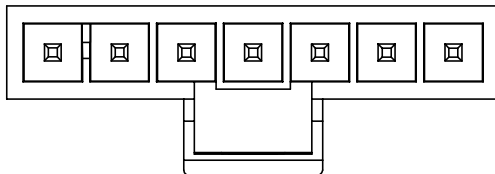


1	2	3	4	5	6	7	8																																				
The product using material and processing must conform to the "WI-PZ-001"HSF technical standard control requirements																																											
RoHS+HF																																											
						NOTE: 1.MATERIAL SPECIFICATION: 1-1.HOUSING: LCP,UL94V-0 1-2.CONTACTS: BRASS 2.PLATING SPECIFICATION: 2-1.CONTACTS: TIN/GOLD FLASH PLATED OVER ALL. 3.ELECTRICAL PERFORMANCE: 3-1.CURRENT RATING: 8A AC/DC 3-2.CONTACT RESISTANCE: 20 mΩ MAX 3-3.INSULATION RESISTANCE: 1000MΩ Min 2-4.DIELECTRIC WITHSTANDING : 1500V 4.ENVIRONMENTAL PERFORMANCE: 4-1.OPERATING TEMPERATURE: -40°C~+105°C. 5.PACKAGE SPEC : TRAY 6.P/N:																																					
						A1 A2514 W 0-1 XX 1 X X X SERIES NO: WATER CODE 0-N/A CONNECTOR: W-WAFER ANGLE: 9-90° 0-180° ROW NO: 1-SINGLE ROW PIN Q'PY: 02~08 COLOR: A-BLACK S-NATURE PLATING: D-MATTE Tin TERMIPOINT: 1-DIP																																					
				Dimensional infotmation(mm) <table><tr><th>Circuits</th><th colspan="2">Dimensions(mm)</th><th>Circuits</th><th colspan="2">Dimensions(mm)</th></tr><tr><td></td><td>A</td><td>B</td><td></td><td>A</td><td>B</td></tr><tr><td>02</td><td>5.94</td><td>2.50</td><td>06</td><td>15.94</td><td>12.50</td></tr><tr><td>03</td><td>8.44</td><td>5.00</td><td>07</td><td>18.44</td><td>15.00</td></tr><tr><td>04</td><td>10.94</td><td>7.50</td><td>08</td><td>20.94</td><td>17.50</td></tr><tr><td>05</td><td>13.44</td><td>10.00</td><td></td><td></td><td></td></tr></table>				Circuits	Dimensions(mm)		Circuits	Dimensions(mm)			A	B		A	B	02	5.94	2.50	06	15.94	12.50	03	8.44	5.00	07	18.44	15.00	04	10.94	7.50	08	20.94	17.50	05	13.44	10.00			
Circuits	Dimensions(mm)		Circuits	Dimensions(mm)																																							
	A	B		A	B																																						
02	5.94	2.50	06	15.94	12.50																																						
03	8.44	5.00	07	18.44	15.00																																						
04	10.94	7.50	08	20.94	17.50																																						
05	13.44	10.00																																									
REV. REVISION RECORD DATE		GENERAL TOLERANCES		SCALE: 1:1		NAME DATE		PART.NO: DWG.NO:																																			
AO NEW RELEASE 21.11.17		LINEAR ANGLES		APPROVED		Wang_jr 23.09.25		A2514W0-1XX1XXX ENDE05																																			
A1 PART NUMBER RENEWAL 23.09.25		0.0±0.35 X°REF±6°		DESIGNER		Han_Gao 23.09.25		TITLE:																																			
		UNIT:mm 0.00±0.25 X'±3°		DRAWN		Zijun_Huang 23.09.25		Pitch 2.50mm MX 单排180° 带扣带定位柱																																			
		SIZE: A4 0.000±0.10 X°X' ±2°						DIP型 Wafer																																			
1	2	3	4	5	6	7	8																																				
				WanLian Technology Co., Ltd																																							
				REV: A1 SHEET: 1/2																																							

	1	2	3	4	5	6	7	8						
A	The product using material and processing must conform to the "WI-PZ-001"HSF technical standard control requirements													
B	RoHS+HF													
C	PIN位示意图													
D														
E	2 CKTS		3 CKTS		4 CKTS		5 CKTS							
F														
G	6 CKTS				7 CKTS									
H	REV.	REVISION RECORD	DATE		GENERAL TOLERANCES		SCALE: 1:1	NAME	DATE	PART.NO:	DWG.NO:	 WanLian Technology Co., Ltd		
	A0	NEW RELEASE	21.11.17		LINEAR	ANGLES	APPROVED	Wang_jr	23.09.25	A2514W0-1XX1XXX				ENDE05
	A1	PART NUMBER RENEWAL	23.09.25		0.0±0.35	X°REF±6°	DESIGNER	Han_Gao	23.09.25	TITLE:				
					UNIT:mm	0.00±0.25	X°±3°	DRAWN	Zijun_Huang	23.09.25	Pitch 2.50mm MX 单排180°带扣带定位柱 DIP型 Wafer		REV: A1	SHEET: 2/2
	1	2	3	4	5	6	7	8						